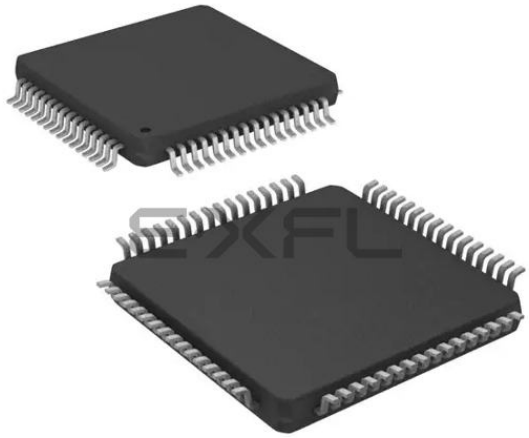

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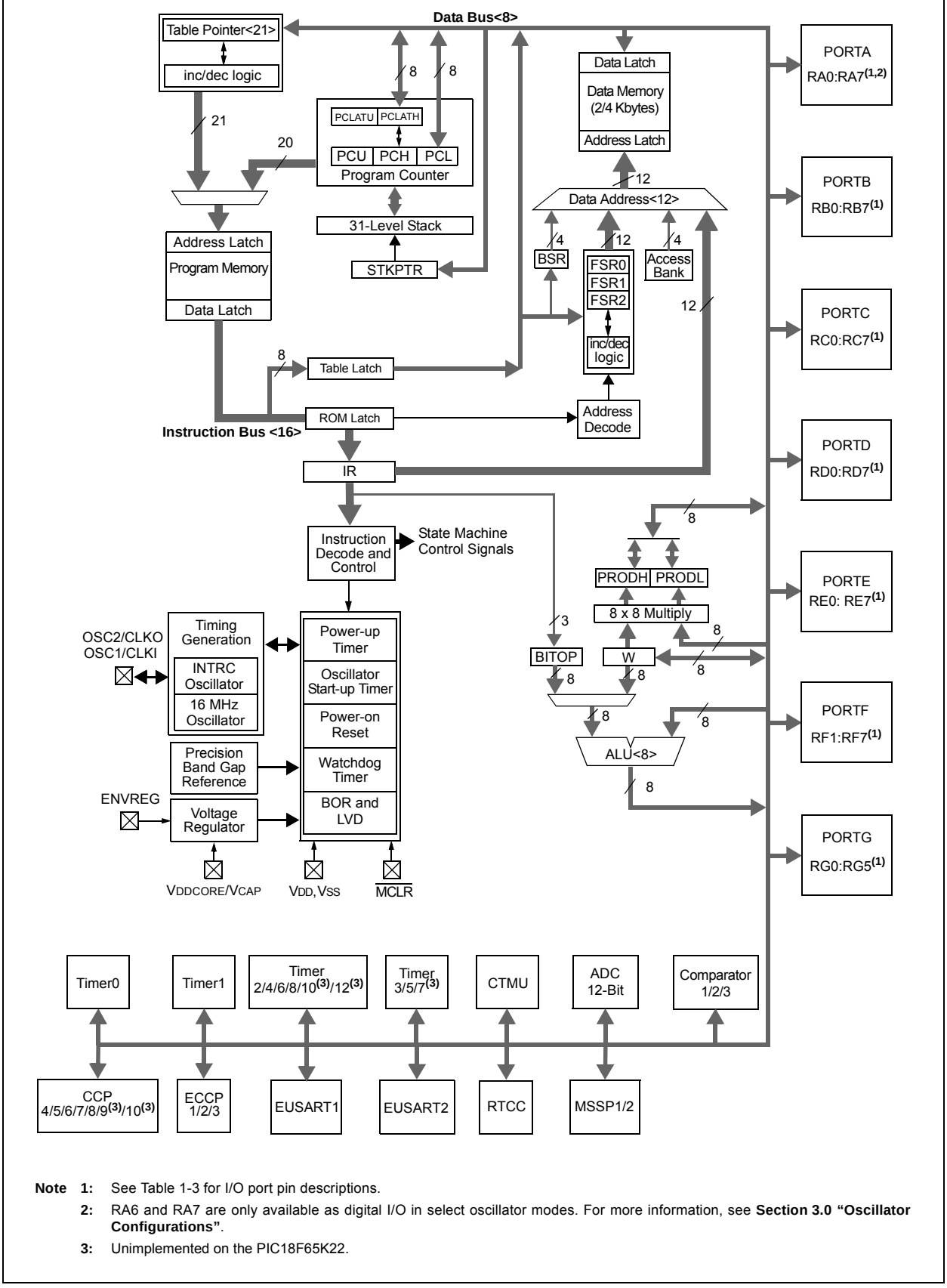
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	53
Program Memory Size	64KB (32K x 16)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 16x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	64-TQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f66k22-e-pt

FIGURE 1-1: PIC18F6XK22 (64-PIN) BLOCK DIAGRAM



Note 1: See Table 1-3 for I/O port pin descriptions.

2: RA6 and RA7 are only available as digital I/O in select oscillator modes. For more information, see **Section 3.0 "Oscillator Configurations"**.

3: Unimplemented on the PIC18F65K22.

TABLE 1-4: PIC18F8XK22 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number	Pin Type	Buffer Type	Description
	TQFP			
				PORTJ is a bidirectional I/O port.
RJ0/ALE	62			
RJ0		I/O	ST	Digital I/O.
ALE		O	—	External memory address latch enable.
RJ1/$\overline{OE}$	61			
RJ1		I/O	ST	Digital I/O.
$\overline{OE}$		O	—	External memory output enable.
RJ2/$\overline{WRL}$	60			
RJ2		I/O	ST	Digital I/O.
$\overline{WRL}$		O	—	External memory write low control.
RJ3/$\overline{WRH}$	59			
RJ3		I/O	ST	Digital I/O.
$\overline{WRH}$		O	—	External memory high control.
RJ4/BA0	39			
RJ4		I/O	ST	Digital I/O.
BA0		O	—	External Memory Byte Address 0 control
RJ5/$\overline{CE}$	40			
RJ5		I/O	ST	Digital I/O
$\overline{CE}$		O	—	External memory chip enable control.
RJ6/$\overline{LB}$	41			
RJ6		I/O	ST	Digital I/O.
$\overline{LB}$		O	—	External memory low byte control.
RJ7/$\overline{UB}$	42			
RJ7		I/O	ST	Digital I/O.
$\overline{UB}$		O	—	External memory high byte control.
VSS	11, 31, 51, 70	P	—	Ground reference for logic and I/O pins.
VDD	32, 48, 71	P	—	Positive supply for logic and I/O pins.
AVSS	26	P	—	Ground reference for analog modules.
AVDD	25	P	—	Positive supply for analog modules.
ENVREG	24	I	ST	Enable for on-chip voltage regulator.
VDDCORE/VCAP	12			Core logic power or external filter capacitor connection.
VDDCORE				
VCAP		P	—	External filter capacitor connection (regulator enabled/disabled).

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to VDD); I^2C = I^2C™/SMBus

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K22 and PIC18F85K22 devices.

4: PSP is available only in Microcontroller mode.

5: The CC6, CCP7, CCP8 and CCP9 pin placement depends on the setting of the ECCPMX Configuration bit (CONFIG3H<1>).

3.0 OSCILLATOR CONFIGURATIONS

3.1 Oscillator Types

The PIC18F87K22 family of devices can be operated in the following oscillator modes:

- EC External clock, RA6 available
- ECIO External clock, clock out RA6 (FOSC/4 on RA6)
- HS High-Speed Crystal/Resonator
- XT Crystal/Resonator
- LP Low-Power Crystal
- RC External Resistor/Capacitor, RA6 available
- RCIO External Resistor/Capacitor, clock out RA6 (FOSC/4 on RA6)
- INTIO2 Internal Oscillator with I/O on RA6 and RA7
- INTIO1 Internal Oscillator with FOSC/4 output on RA6 and I/O on RA7

There is also an option for running the 4xPLL on any of the clock sources in the input frequency range of 4 to 16 MHz.

The PLL is enabled by setting the PLLCFG bit (CONFIG1H<4>) or the PLLEN bit (OSCTUNE<6>).

For the EC and HS mode, the PLLEN (software) or PLLCFG (CONFIG) bit can be used to enable the PLL.

For the INTIOx modes (HF-INTOSC):

- Only the PLLEN can enable the PLL (PLLCFG is ignored).
- When the oscillator is configured for the internal oscillator (FOSC<3:0> = 100x), the PLL can be enabled only when the HF-INTOSC frequency is 8 or 16 MHz.

When the RA6 and RA7 pins are not used for an oscillator function or CLKOUT function, they are available as general purpose I/Os.

To optimize power consumption when using EC/HS/XT/LP/RC as the primary oscillator, the frequency input range can be configured to yield an optimized power bias:

- Low-Power Bias – External frequency less than 160 kHz
- Medium Power Bias – External frequency between 160 kHz and 16 MHz
- High-Power Bias – External frequency greater than 16 MHz

All of these modes are selected by the user by programming the FOSC<3:0> Configuration bits (CONFIG1H<3:0>). In addition, PIC18F87K22 family devices can switch between different clock sources, either under software control or, under certain conditions, automatically. This allows for additional power savings by managing device clock speed in real time without resetting the application. The clock sources for the PIC18F87K22 family of devices are shown in Figure 3-1.

For the HS and EC mode, there are additional power modes of operation – depending on the frequency of operation.

HS1 is the Medium Power mode with a frequency range of 4 MHz to 16 MHz. HS2 is the High-Power mode, where the oscillator frequency can go from 16 MHz to 25 MHz. HS1 and HS2 are achieved by setting the CONFIG1H<3:0> correctly. (For details, see Register 28-2 on page 406.)

EC mode has these modes of operation:

- EC1 – For low power with a frequency range up to 160 kHz
- EC2 – Medium power with a frequency range of 160 kHz to 16 MHz
- EC3 – High power with a frequency range of 16 MHz to 64 MHz

EC1, EC2 and EC3 are achieved by setting the CONFIG1H<3:0> correctly. (For details, see Register 28-2 on page 406.)

Table 3-1 shows the HS and EC modes' frequency range and FOSC<3:0> settings.

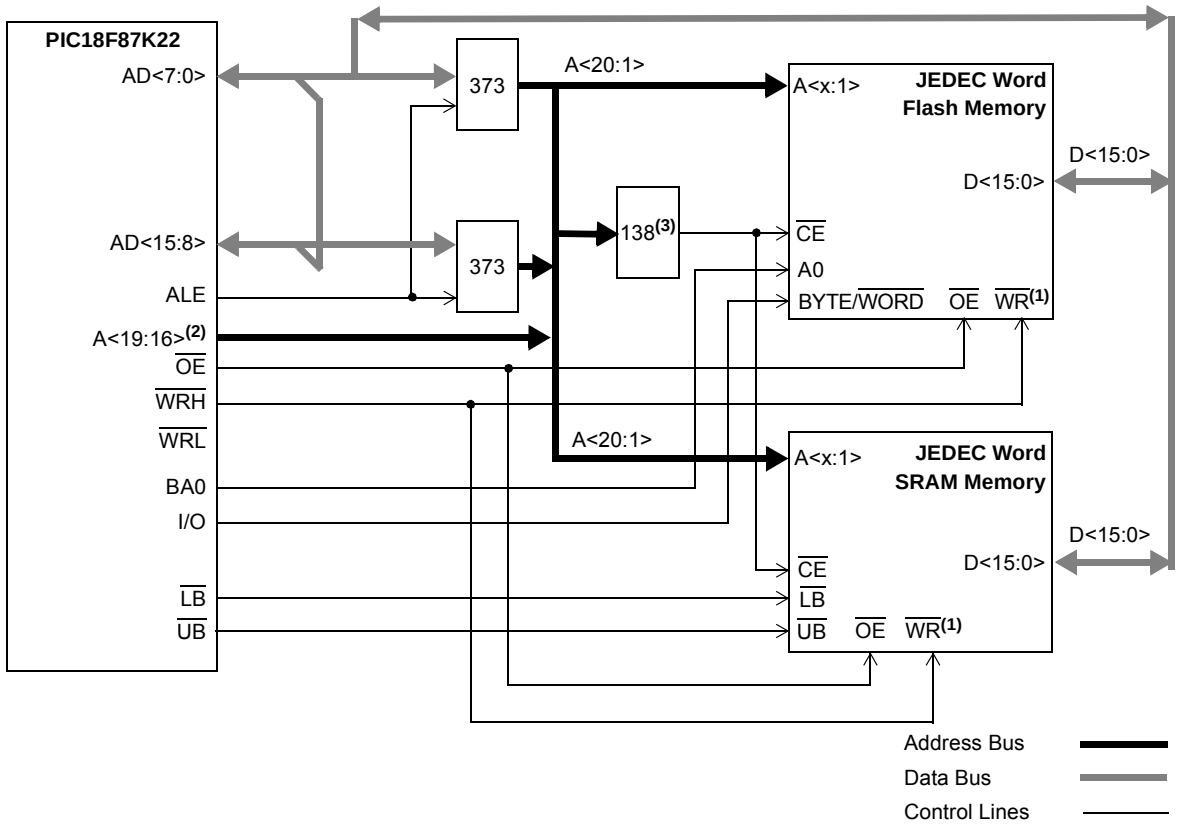
8.6.3 16-BIT BYTE SELECT MODE

Figure 8-3 shows an example of 16-Bit Byte Select mode. This mode allows table write operations to word-wide external memories with byte selection capability. This generally includes both word-wide Flash and SRAM devices.

During a TBLWT cycle, the TABLAT data is presented on the upper and lower byte of the AD<15:0> bus. The $\overline{WRH}$ signal is strobed for each write cycle; the $\overline{WRL}$ pin is not used. The BA0 or $\overline{UB}$/$\overline{LB}$ signals are used to select the byte to be written, based on the Least Significant bit of the TBLPTR register.

Flash and SRAM devices use different control signal combinations to implement Byte Select mode. JEDEC standard Flash memories require that a controller I/O port pin be connected to the memory's BYTE/$\overline{WORD}$ pin to provide the select signal. They also use the BA0 signal from the controller as a byte address. JEDEC standard static RAM memories, on the other hand, use the $\overline{UB}$ or $\overline{LB}$ signals to select the byte.

FIGURE 8-3: 16-BIT BYTE SELECT MODE EXAMPLE



Note 1: This signal only applies to table writes. See **Section 7.1 "Table Reads and Table Writes"**.

2: Upper order address lines are used only for 20-bit address width.

3: Demultiplexing is only required when multiple memory devices are accessed.

13.0 TIMER0 MODULE

The Timer0 module incorporates the following features:

- Software-selectable operation as a timer or counter in both 8-bit or 16-bit modes
- Readable and writable registers
- Dedicated 8-bit, software programmable prescaler
- Selectable clock source (internal or external)
- Edge select for external clock
- Interrupt-on-overflow

The T0CON register (Register 13-1) controls all aspects of the module's operation, including the prescale selection. It is both readable and writable.

Figure 13-1 provides a simplified block diagram of the Timer0 module in 8-bit mode. Figure 13-2 provides a simplified block diagram of the Timer0 module in 16-bit mode.

REGISTER 13-1: T0CON: TIMER0 CONTROL REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
TMR0ON	T08BIT	T0CS	T0SE	PSA	T0PS2	T0PS1	T0PS0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **TMR0ON:** Timer0 On/Off Control bit
1 = Enables Timer0
0 = Stops Timer0

bit 6 **T08BIT**: Timer0 8-Bit/16-Bit Control bit
1 = Timer0 is configured as an 8-bit timer/counter
0 = Timer0 is configured as a 16-bit timer/counter

bit 5 **T0CS**: Timer0 Clock Source Select bit
1 = Transition on T0CKI pin input edge
0 = Internal clock (FOSC/4)

bit 4 **T0SE**: Timer0 Source Edge Select bit
1 = Increment on high-to-low transition on T0CKI pin
0 = Increment on low-to-high transition on T0CKI pin

bit 3 **PSA**: Timer0 Prescaler Assignment bit
1 = Timer0 prescaler is not assigned; Timer0 clock input bypasses prescaler
0 = Timer0 prescaler is assigned; Timer0 clock input comes from prescaler output

bit 2-0 **T0PS<2:0>**: Timer0 Prescaler Select bits
111 = 1:256 Prescale value
110 = 1:128 Prescale value
101 = 1:64 Prescale value
100 = 1:32 Prescale value
011 = 1:16 Prescale value
010 = 1:8 Prescale value
001 = 1:4 Prescale value
000 = 1:2 Prescale value

16.5.2 TIMER3/5/7 GATE SOURCE SELECTION

The Timer3/5/7 gate source can be selected from one of four different sources. Source selection is controlled by the TxGSS<1:0> bits (TxGCON<1:0>). The polarity for each available source is also selectable and is controlled by the TxGPOL bit (TxGCON <6>).

TABLE 16-2: TIMER3/5/7 GATE SOURCES

TxGSS<1:0>	Timerx Gate Source
00	Timerx Gate Pin
01	TMR(x+1) to Match PR(x+1) (TMR(x+1) increments to match PR(x+1))
10	Comparator 1 Output (comparator logic high output)
11	Comparator 2 Output (comparator logic high output)

16.5.2.1 TxG Pin Gate Operation

The TxG pin is one source for Timer3/5/7 gate control. It can be used to supply an external source to the Timerx gate circuitry.

16.5.2.2 Timer4/6/8 Match Gate Operation

The TMR(x+1) register will increment until it matches the value in the PR(x+1) register. On the very next increment cycle, TMR2 will be reset to 00h. When this Reset occurs, a low-to-high pulse will automatically be generated and internally supplied to the Timerx gate circuitry. The pulse will remain high for one instruction cycle and will return back to a low state until the next match.

Depending on TxGPOL, Timerx increments differently when TMR(x+1) matches PR(x+1). When TxGPOL = 1, Timerx increments for a single instruction cycle following a TMR(x+1) match with PR(x+1). When TxGPOL = 0, Timerx increments continuously, except for the cycle following the match, when the gate signal goes from low-to-high.

16.5.2.3 Comparator 1 Output Gate Operation

The output of Comparator 1 can be internally supplied to the Timerx gate circuitry. After setting up Comparator 1 with the CM1CON register, Timerx will increment depending on the transitions of the CMP1OUT (CMSTAT<5>) bit.

16.5.2.4 Comparator 2 Output Gate Operation

The output of Comparator 2 can be internally supplied to the Timerx gate circuitry. After setting up Comparator 2 with the CM2CON register, Timerx will increment depending on the transitions of the CMP2OUT (CMSTAT<6>) bit.

16.5.3 TIMER3/5/7 GATE TOGGLE MODE

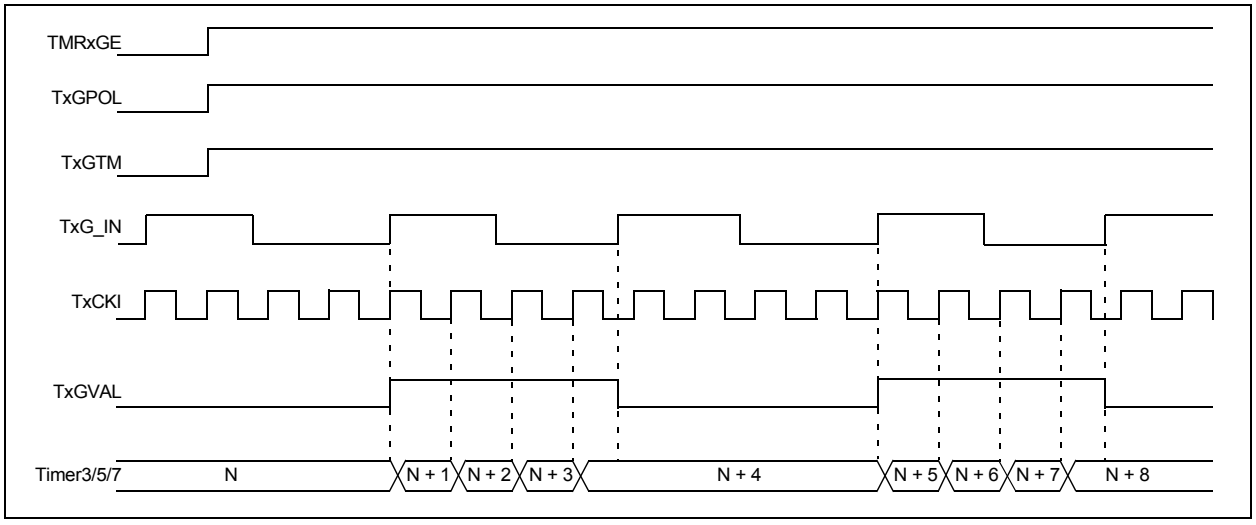
When Timer3/5/7 Gate Toggle mode is enabled, it is possible to measure the full cycle length of a Timer3/5/7 gate signal, as opposed to the duration of a single level pulse.

The Timerx gate source is routed through a flip-flop that changes state on every incrementing edge of the signal. (For timing details, see Figure 16-3.)

The TxGVAL bit will indicate when the Toggled mode is active and the timer is counting.

Timer3/5/7 Gate Toggle mode is enabled by setting the TxGTM bit (TxGCON<5>). When the TxGTM bit is cleared, the flip-flop is cleared and held clear. This is necessary in order to control which edge is measured.

FIGURE 16-3: TIMER3/5/7 GATE TOGGLE MODE



REGISTER 18-4: ALRMCFG: ALARM CONFIGURATION REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ALRMEN	CHIME	AMASK3	AMASK2	AMASK1	AMASK0	ALRMPTR1	ALRMPTR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **ALRMEN:** Alarm Enable bit

1 = Alarm is enabled (cleared automatically after an alarm event whenever ARPT<7:0> = 00 and CHIME = 0)
0 = Alarm is disabled

bit 6 **CHIME:** Chime Enable bit

1 = Chime is enabled; ALRMPTR<1:0> bits are allowed to roll over from 00h to FFh
0 = Chime is disabled; ALRMPTR<1:0> bits stop once they reach 00h

bit 5-2 **AMASK<3:0>:** Alarm Mask Configuration bits

0000 = Every half second
0001 = Every second
0010 = Every 10 seconds
0011 = Every minute
0100 = Every 10 minutes
0101 = Every hour
0110 = Once a day
0111 = Once a week
1000 = Once a month
1001 = Once a year (except when configured for February 29th, once every four years)
101x = Reserved – Do not use
11xx = Reserved – Do not use

bit 1-0 **ALRMPTR<1:0>:** Alarm Value Register Window Pointer bits

Points to the corresponding Alarm Value registers when reading the ALRMVALH and ALRMVALL registers. The ALRMPTR<1:0> value decrements on every read or write of ALRMVALH until it reaches '00'.

ALRMVALH:
00 = ALRMMIN
01 = ALRMWD
10 = ALRMMNTH
11 = Unimplemented

ALRMVALL:
00 = ALRMSEC
01 = ALRMHR
10 = ALRMDAY
11 = Unimplemented

REGISTER 21-2: SSPxCON1: MSSPx CONTROL REGISTER 1 (SPI MODE)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WCOL	SSPOV(1)	SSPEN(2)	CKP	SSPM3(3)	SSPM2(3)	SSPM1(3)	SSPM0(3)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **WCOL:** Write Collision Detect bit
- 1 = The SSPxBUF register is written while it is still transmitting the previous word (must be cleared in software)
- 0 = No collision

bit 6 **SSPOV:** Receive Overflow Indicator bit(1)

SPI Slave mode:
- 1 = A new byte is received while the SSPxBUF register is still holding the previous data. In case of overflow, the data in SSPxSR is lost. Overflow can only occur in Slave mode. The user must read the SSPxBUF, even if only transmitting data, to avoid setting overflow (must be cleared in software).
- 0 = No overflow

bit 5 **SSPEN:** Master Synchronous Serial Port Enable bit(2)
- 1 = Enables serial port and configures SCKx, SDOx, SDIx and $\overline{SSx}$ as serial port pins
- 0 = Disables serial port and configures these pins as I/O port pins

bit 4 **CKP:** Clock Polarity Select bit
- 1 = Idle state for the clock is a high level
- 0 = Idle state for the clock is a low level

bit 3-0 **SSPM<3:0>:** Master Synchronous Serial Port Mode Select bits(3)
- 1010 = SPI Master mode: clock = FOSC/8
- 0101 = SPI Slave mode: clock = SCKx pin; $\overline{SSx}$ pin control disabled; $\overline{SSx}$ can be used as I/O pin
- 0100 = SPI Slave mode: clock = SCKx pin; $\overline{SSx}$ pin control enabled
- 0011 = SPI Master mode: clock = TMR2 output/2
- 0010 = SPI Master mode: clock = FOSC/64
- 0001 = SPI Master mode: clock = FOSC/16
- 0000 = SPI Master mode: clock = FOSC/4

Note 1: In Master mode, the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPxBUF register.

2: When enabled, these pins must be properly configured as inputs or outputs.

3: Bit combinations not specifically listed here are either reserved or implemented in I^2C™ mode only.

REGISTER 21-5: SSPxCON2: MSSPx CONTROL REGISTER 2 (I^2C™ MASTER MODE)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GCEN	ACKSTAT	ACKDT(1)	ACKEN(2)	RCEN(2)	PEN(2)	RSEN(2)	SEN(2)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **GCEN:** General Call Enable bit
Unused in Master mode.

bit 6 **ACKSTAT:** Acknowledge Status bit (Master Transmit mode only)
1 = Acknowledge was not received from slave
0 = Acknowledge was received from slave

bit 5 **ACKDT:** Acknowledge Data bit (Master Receive mode only)(1)
1 = Not Acknowledge
0 = Acknowledge

bit 4 **ACKEN:** Acknowledge Sequence Enable bit(2)
1 = Initiates Acknowledge sequence on SDAx and SCLx pins and transmits ACKDT data bit. Automatically cleared by hardware.
0 = Acknowledge sequence is Idle

bit 3 **RCEN:** Receive Enable bit (Master Receive mode only)(2)
1 = Enables Receive mode for I^2C™
0 = Receive is Idle

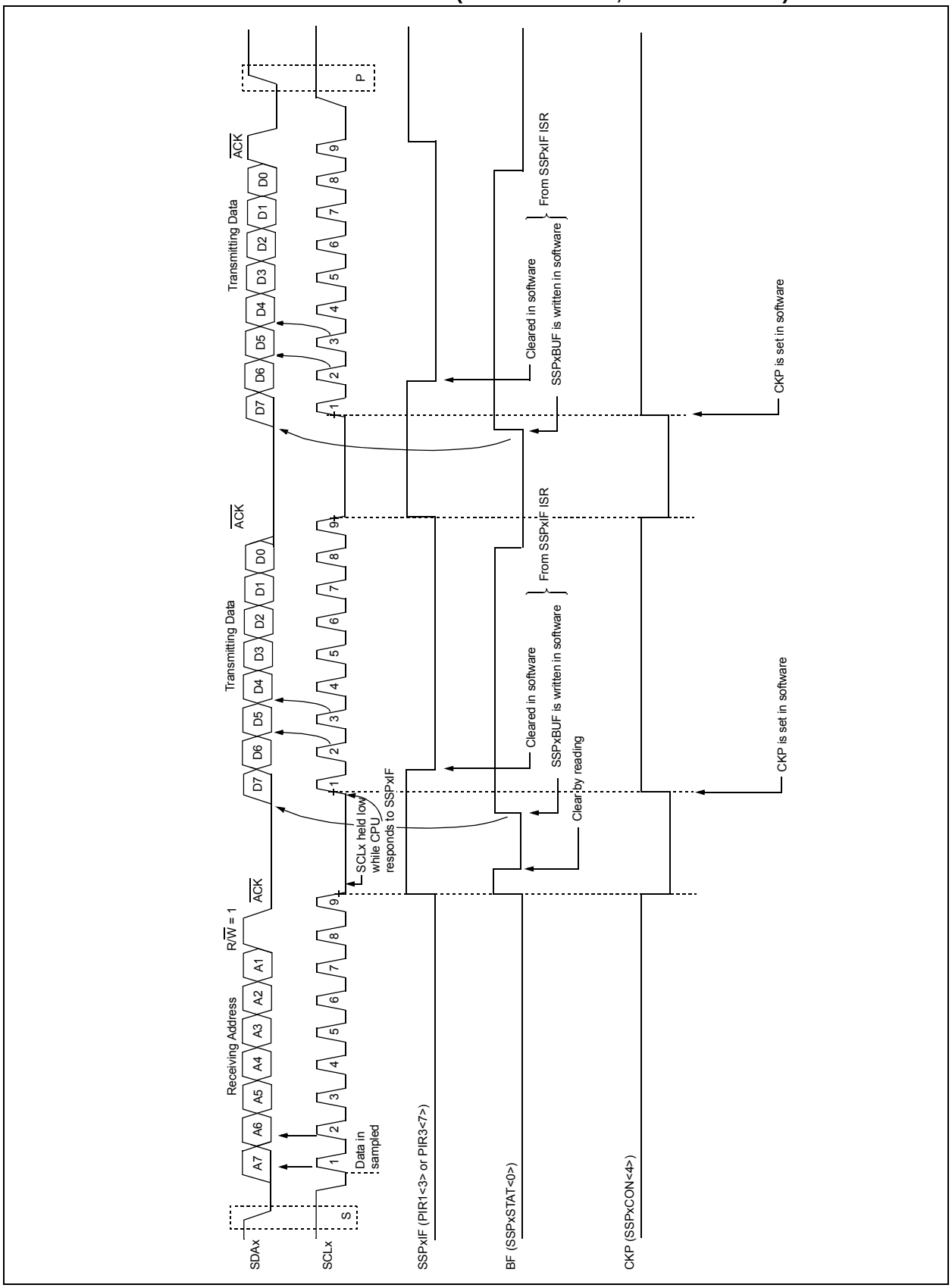
bit 2 **PEN:** Stop Condition Enable bit(2)
1 = Initiates Stop condition on SDAx and SCLx pins. Automatically cleared by hardware.
0 = Stop condition is Idle

bit 1 **RSEN:** Repeated Start Condition Enable bit(2)
1 = Initiates Repeated Start condition on SDAx and SCLx pins. Automatically cleared by hardware.
0 = Repeated Start condition is Idle

bit 0 **SEN:** Start Condition Enable bit(2)
1 = Initiates Start condition on SDAx and SCLx pins. Automatically cleared by hardware.
0 = Start condition is Idle

Note 1: Value that will be transmitted when the user initiates an Acknowledge sequence at the end of a receive.
2: If the I^2C module is active, these bits may not be set (no spooling) and the SSPxBUF may not be written (or writes to the SSPxBUF are disabled).

FIGURE 21-10: I²C™ SLAVE MODE TIMING (TRANSMISSION, 7-BIT ADDRESS)



21.4.17.1 Bus Collision During a Start Condition

During a Start condition, a bus collision occurs if:

a) SDAx or SCLx is sampled low at the beginning of the Start condition (Figure 21-28).

b) SCLx is sampled low before SDAx is asserted low (Figure 21-29).

During a Start condition, both the SDAx and the SCLx pins are monitored.

If the SDAx pin is already low, or the SCLx pin is already low, then all of the following occur:

- The Start condition is aborted
- The BCLxIF flag is set
- The MSSP module is reset to its inactive state (Figure 21-28)

The Start condition begins with the SDAx and SCLx pins deasserted. When the SDAx pin is sampled high, the Baud Rate Generator is loaded from SSPxADD<6:0> and counts down to 0. If the SCLx pin is sampled low while SDAx is high, a bus collision occurs because it is assumed that another master is attempting to drive a data '1' during the Start condition.

If the SDAx pin is sampled low during this count, the BRG is reset and the SDAx line is asserted early (Figure 21-30). If, however, a '1' is sampled on the SDAx pin, the SDAx pin is asserted low at the end of the BRG count. The Baud Rate Generator is then reloaded and counts down to 0. If the SCLx pin is sampled as '0' during this time, a bus collision does not occur. At the end of the BRG count, the SCLx pin is asserted low.

Note:	The reason that a bus collision is not a factor during a Start condition is that no two bus masters can assert a Start condition at the exact same time. Therefore, one master will always assert SDAx before the other. This condition does not cause a bus collision because the two masters must be allowed to arbitrate the first address following the Start condition. If the address is the same, arbitration must be allowed to continue into the data portion, Repeated Start or Stop conditions.

FIGURE 21-28: BUS COLLISION DURING START CONDITION (SDAx ONLY)

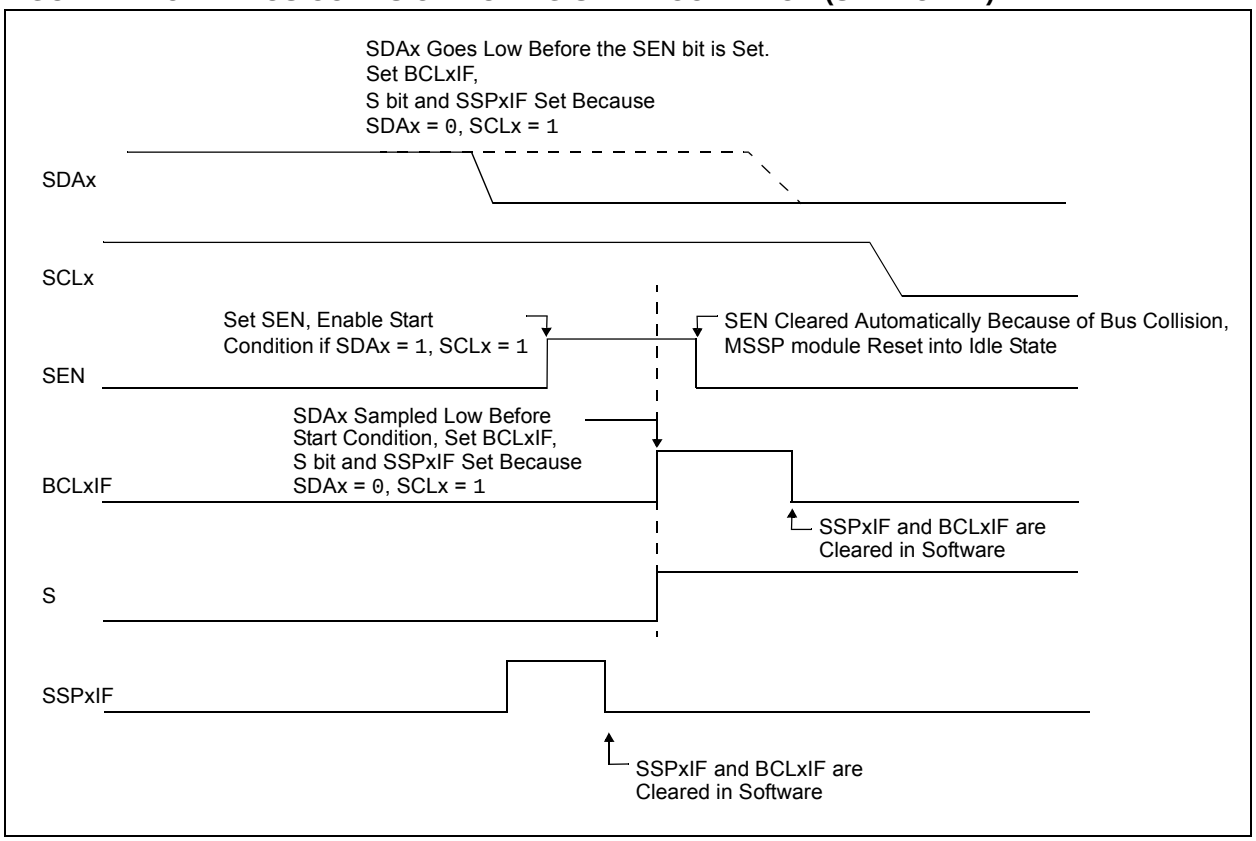
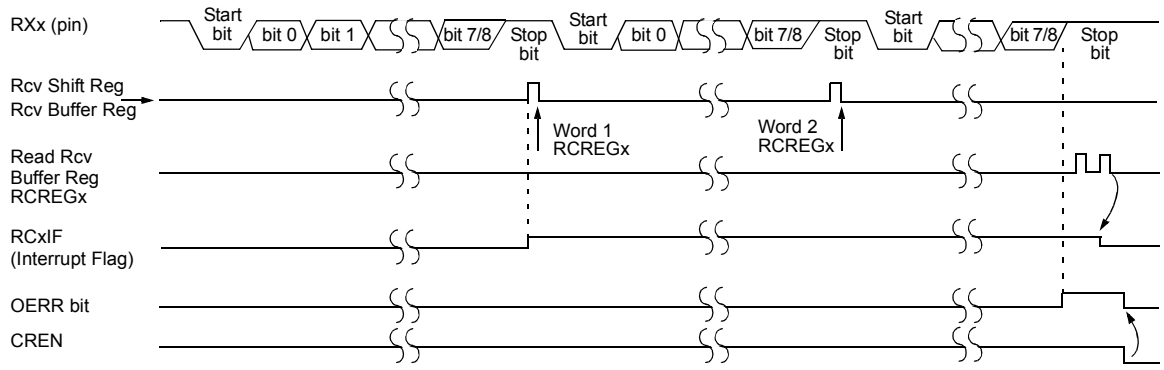


FIGURE 22-7: ASYNCHRONOUS RECEPTION



Note: This timing diagram shows three words appearing on the RXx input. The RCREGx (Receive Buffer) is read after the third word, causing the OERR (Overrun) bit to be set.

TABLE 22-6: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP
PIR3	TMR5GIF	—	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF
PIE3	TMR5GIE	—	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE
IPR3	TMR5GIP	—	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D
RCREG1	EUSART1 Receive Register							
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D
BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN
SPBRGH1	EUSART1 Baud Rate Generator Register High Byte							
SPBRG1	EUSART1 Baud Rate Generator Register							
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D
RCREG2	EUSART2 Receive Register							
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D
BAUDCON2	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN
SPBRGH2	EUSART2 Baud Rate Generator Register High Byte							
SPBRG2	EUSART2 Baud Rate Generator Register							
ODCON3	U2OD	U1OD	—	—	—	—	—	CTMUDS
PMD0	CCP3MD	CCP2MD	CCP1MD	UART2MD	UART1MD	SSP2MD	SSP1MD	ADCMD

Legend: — = unimplemented locations read as '0'. Shaded cells are not used for asynchronous reception.

23.0 12-BIT ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The Analog-to-Digital (A/D) Converter module in the PIC18F87K22 family of devices has 16 inputs for the 64-pin devices and 24 inputs for the 80-pin devices. This module allows conversion of an analog input signal to a corresponding 12-bit digital number.

The module has these registers:

- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)
- A/D Control Register 2 (ADCON2)
- A/D Port Configuration Register 0 (ANCON0)
- A/D Port Configuration Register 1 (ANCON1)
- A/D Port Configuration Register 2 (ANCON2)
- ADRESH (the upper, A/D Results register)
- ADRESL (the lower, A/D Results register)

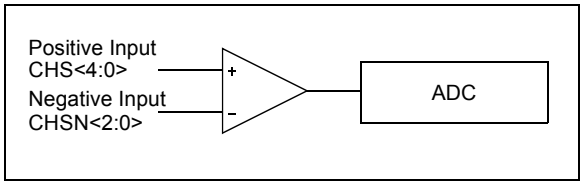
The ADCON0 register, shown in Register 23-1, controls the operation of the A/D module. The ADCON1 register, shown in Register 23-2, configures the voltage reference and special trigger selection. The ADCON2 register, shown in Register 23-3, configures the A/D clock source and programmed acquisition time and justification.

23.1 Differential A/D Converter

The converter in PIC18F87K22 family devices is implemented as a differential A/D where the differential voltage between two channels is measured and converted to digital values (see Figure 23-1).

The converter can also be configured to measure a voltage from a single input by clearing the CHSN bits (ADCON1<2:0>). With this configuration, the negative channel input is connected internally to AVSS (see Figure 23-2).

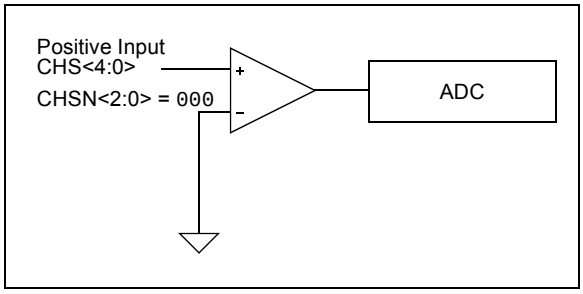
FIGURE 23-1: DIFFERENTIAL CHANNEL MEASUREMENT



Differential conversion feeds the two input channels to a unity gain differential amplifier. The positive channel input is selected using the CHS bits (ADCON0<6:2>) and the negative channel input is selected using the CHSN bits (ADCON1<2:0>).

The output from the amplifier is fed to the A/D Converter, as shown in Figure 23-1. The 12-bit result is available on the ADRESH and ADRESL registers. An additional bit indicates if the 12-bit result is a positive or negative value.

FIGURE 23-2: SINGLE CHANNEL MEASUREMENT



In the Single Channel Measurement mode, the negative input is connected to AVSS by clearing the CHSN bits (ADCON1<2:0>).

EXAMPLE 27-1: SETUP FOR CTMU CALIBRATION ROUTINES

```
#include "p18cxxx.h"
/*****************************************************************************/
/*Setup CTMU *****************************************************************/
/*****************************************************************************/
void setup(void)

{ //CTMUCON - CTMU Control register

    CTMUCONH = 0x00;              //make sure CTMU is disabled
    CTMUCONL = 0X90;
    //CTMU continues to run when emulator is stopped,CTMU continues
    //to run in idle mode,Time Generation mode disabled, Edges are blocked
    //No edge sequence order, Analog current source not grounded, trigger
    //output disabled, Edge2 polarity = positive level, Edge2 source =
    //source 0, Edge1 polarity = positive level, Edge1 source = source 0,
    // Set Edge status bits to zero


    //CTMUICON - CTMU Current Control Register
    CTMUICON = 0x01;              //0.55uA, Nominal - No Adjustment

/*****************************************************************************/
//Setup AD converter;
/*****************************************************************************/

    TRISA=0x04;                   //set channel 2 as an input

    // Configured AN2 as an analog channel
    // ANCON0
    ANCON0 = 0X04;
    // ANCON1
    ANCON1 = 0XE0;

    // ADCON2
    ADCON2bits.ADFM=1;            // Resulst format 1= Right justified
    ADCON2bits.ACQT=1;            // Acquition time 7 = 20TAD 2 = 4TAD 1=2TAD
    ADCON2bits.ADCS=2;            // Clock conversion bits 6= FOSC/64 2=FOSC/32

    // ADCON0
    ADCON1bits.VCFG0 =0;          // Vref+ = AVdd
    ADCON0bits.VCFG1 =0;          // Vref+ = AVdd
    ADCON0bits.VCFG = 0;          // Vref- = AVss
    ADCON0bits.CHS=2;             // Select ADC channel

    ADCON0bits.ADON=1;            // Turn on ADC

}
```

REGISTER 28-11: CONFIG6H: CONFIGURATION REGISTER 6 HIGH (BYTE ADDRESS 30000Bh)

R/C-1	R/C-1	R-1	U-0	U-0	U-0	U-0	U-0
WRTD	WRTB	WRTC(1)	—	—	—	—	—
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **WRTD:** Data EEPROM Write Protection bit
1 = Data EEPROM is not write-protected
0 = Data EEPROM is write-protected

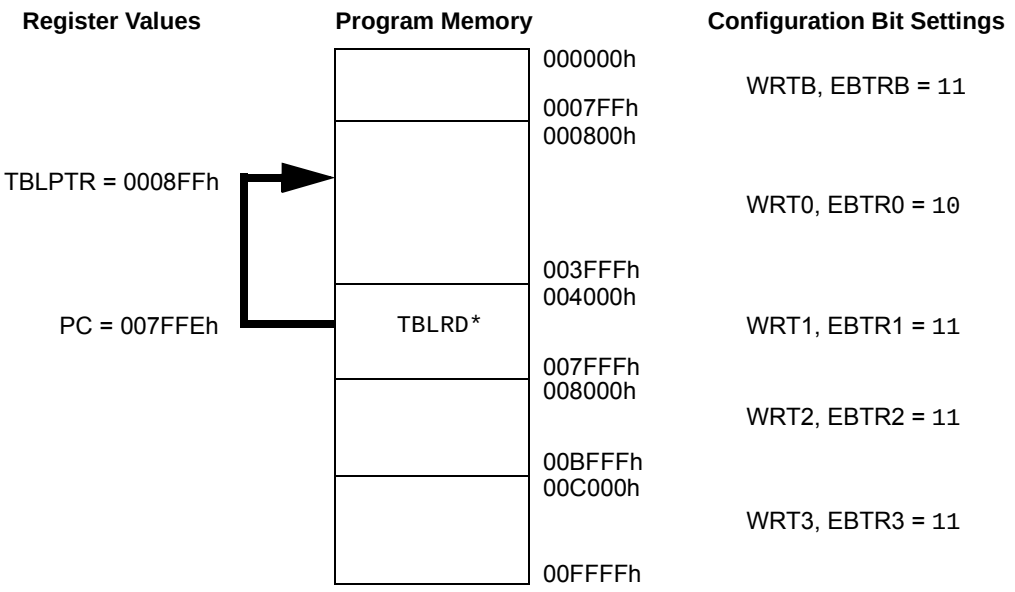
bit 6 **WRTB:** Boot Block Write Protection bit
1 = Boot block is not write-protected(2)
0 = Boot block is write-protected(2)

bit 5 **WRTC:** Configuration Register Write Protection bit(1)
1 = Configuration registers are not write-protected(2)
0 = Configuration registers are write-protected(2)

bit 4-0 **Unimplemented:** Read as '0'

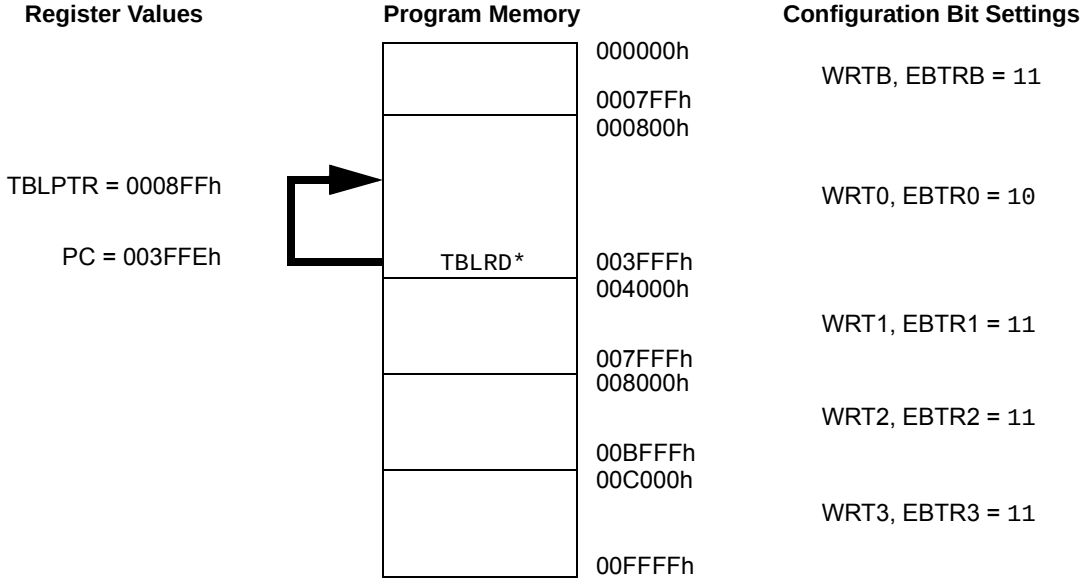
Note 1: This bit is read-only in normal Execution mode; it can be written only in Program mode.
2: For the memory size of the blocks, see Figure 28-6.

FIGURE 28-8: EXTERNAL BLOCK TABLE READ (EBTRx) DISALLOWED



Results: All table reads from external blocks to Blockn are disabled whenever EBTRx = 0. The TABLAT register returns a value of '0'.

FIGURE 28-9: EXTERNAL BLOCK TABLE READ (EBTRx) ALLOWED



Results: Table reads are permitted within Blockn, even when EBTRBx = 0.
The TABLAT register returns the value of the data at the location, TBLPTR.

BCF **Bit Clear f**

Syntax: BCF f, b {,a}

Operands: $0 \le f \le 255$
$0 \le b \le 7$
$a \in [0,1]$

Operation: $0 \rightarrow f<b>$

Status Affected: None

Encoding:

1001	bbba	ffff	ffff

Description: Bit 'b' in register 'f' is cleared.

If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See **Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write register 'f'

Example: `BCF FLAG_REG, 7, 0`

Before Instruction
FLAG_REG = C7h
After Instruction
FLAG_REG = 47h

BN **Branch if Negative**

Syntax: BN n

Operands: $-128 \le n \le 127$

Operation: if Negative bit is '1',
$(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding:

1110	0110	nnnn	nnnn

Description: If the Negative bit is '1', then the program will branch.

The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.

Words: 1

Cycles: 1(2)

Q Cycle Activity:
If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	No operation

Example:
```
HERE    BN   Jump
```
Before Instruction
PC = address (HERE)
After Instruction
If Negative = 1;
PC = address (Jump)
If Negative = 0;
PC = address (HERE + 2)

30.11 PICkit 2 Development Programmer/Debugger and PICkit 2 Debug Express

The PICkit™ 2 Development Programmer/Debugger is a low-cost development tool with an easy to use interface for programming and debugging Microchip's Flash families of microcontrollers. The full featured Windows® programming interface supports baseline (PIC10F, PIC12F5xx, PIC16F5xx), midrange (PIC12F6xx, PIC16F), PIC18F, PIC24, dsPIC30, dsPIC33, and PIC32 families of 8-bit, 16-bit, and 32-bit microcontrollers, and many Microchip Serial EEPROM products. With Microchip's powerful MPLAB Integrated Development Environment (IDE) the PICkit™ 2 enables in-circuit debugging on most PIC® microcontrollers. In-Circuit-Debugging runs, halts and single steps the program while the PIC microcontroller is embedded in the application. When halted at a breakpoint, the file registers can be examined and modified.

The PICkit 2 Debug Express include the PICkit 2, demo board and microcontroller, hookup cables and CDROM with user's guide, lessons, tutorial, compiler and MPLAB IDE software.

30.12 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at V_{DDMIN} and V_{DDMAX} for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages and a modular, detachable socket assembly to support various package types. The ICSP™ cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices and incorporates an MMC card for file storage and data applications.

30.13 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM™ and dsPICDEM™ demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ® security ICs, CAN, IrDA®, PowerSmart battery management, SEEVAL® evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

31.2 DC Characteristics: Power-Down and Supply Current PIC18F87K22 Family (Industrial/Extended) (Continued)

PIC18F87K22 Family (Industrial/Extended)		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended					
Param No.	**Device**	**Typ**	**Max**	**Units**	**Conditions**		
D025 (ΔIRTCC)	**Real-Time Clock/Calendar with SOSC Oscillator**						
	All devices	0.7	2.7	µA	-40°C	VDD = 1.8V(4) Regulator Disabled	32.768 kHz, SOSCRUN = 1
		0.7	2.8	µA	+25°C		
		1.1	2.8	µA	+60°C		
		1.1	2.9	µA	+85°C		
		2.2	4.4	µA	+125ºC		
	All devices	1.2	2.9	µA	-40°C	VDD = 3.3V(4) Regulator Disabled	
		1.1	2.8	µA	+25°C		
		2	4.6	µA	+60°C		
		2	4.8	µA	+85°C		
		4	6.5	µA	+125ºC		
	All devices	1.5	4.4	µA	-40°C	VDD = 5V(5) Regulator Enabled	
		1.5	4.4	µA	+25°C		
		1.7	4.7	µA	+60°C		
		1.7	4.7	µA	+85°C		
		3.5	6.9	µA	+125ºC		

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or VSS, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.
The test conditions for all IDD measurements in Active Operation mode are:
OSC1 = External square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;
$\overline{MCLR}$ = VDD; WDT enabled/disabled as specified.

3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

4: Voltage regulator disabled (ENVREG = 0, tied to VSS, $\overline{RETEN}$ (CONFIG1L<0>) = 1).

5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and $\overline{RETEN}$ (CONFIG1L<0>) = 0).

6: 48 MHz, maximum frequency at +125ºC.

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